

Title (en)  
NANOCARBON/ALUMINUM COMPOSITE MATERIAL, PROCESS FOR PRODUCING THE SAME, AND PLATING LIQUID FOR USE IN SAID PROCESS

Title (de)  
NANOKOHLENSTOFF/ALUMINIUM-VERBUNDWERKSTOFF, HERSTELLUNGSVERFAHREN DAFÜR UND PLATTIERUNGSFLÜSSIGKEIT ZUR VERWENDUNG BEI DEM VERFAHREN

Title (fr)  
MATIÈRE COMPOSITE DE NANOCARBONE/ALUMINIUM, PROCÉDÉ SERVANT À PRODUIRE CELLE-CI ET LIQUIDE DE PLACAGE DESTINÉ À ÊTRE UTILISÉ DANS LEDIT PROCÉDÉ

Publication  
**EP 1930481 A1 20080611 (EN)**

Application  
**EP 06766838 A 20060616**

Priority  
• JP 2006312152 W 20060616  
• JP 2005258646 A 20050907

Abstract (en)  
[Object] To provide a nanocarbon/aluminum composite material having high strength and electrical conductivity for suitable use in a lead wire, a heat exchanger and an automotive part and a process for producing the nanocarbon/aluminum composite material. [Solution] There is provided a plating liquid for nanocarbon/aluminum composite production, comprising an aluminum halide, nanocarbon and 1,3-dialkylimidazolium halide and/or the like, wherein the molar ratio of the aluminum halide to the 1,3-dialkylimidazolium halide and/or the like is in the range of 20:80 to 80:20 and the 1,3-dialkylimidazolium halide and/or the like has an alkyl group with a carbon number of 1 to 12. There are also provided a nanocarbon/aluminum composite production process comprising forming a plating film on a substrate surface by electrolysis of the plating liquid in a dry, oxygen-free atmosphere with the passage of a direct current etc. under the electrolysis conditions of a bath temperature of 0 to 300 °C and a current density of 0.01 to 50 A/dm<sup>2</sup> and a nanocarbon/aluminum composite material produced by this production process.

IPC 8 full level  
**C25D 15/02** (2006.01); **C25D 3/66** (2006.01)

CPC (source: EP US)  
**C25D 3/665** (2013.01 - EP US); **C25D 5/18** (2013.01 - EP US); **C25D 15/02** (2013.01 - EP US)

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